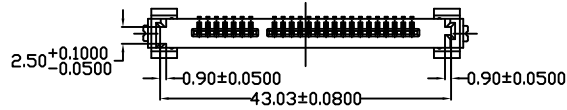


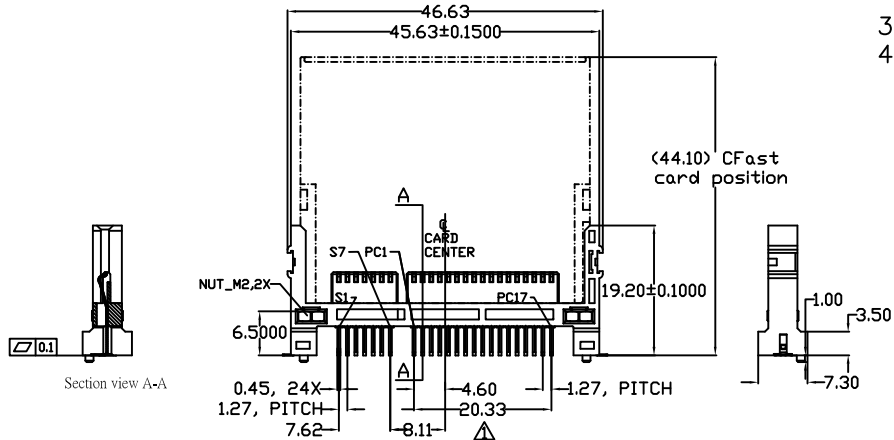
1 2 3 4 5 6 7 8 9 10

A

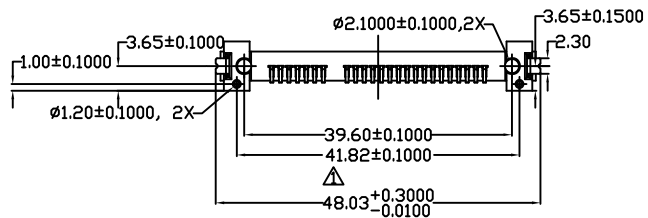


B

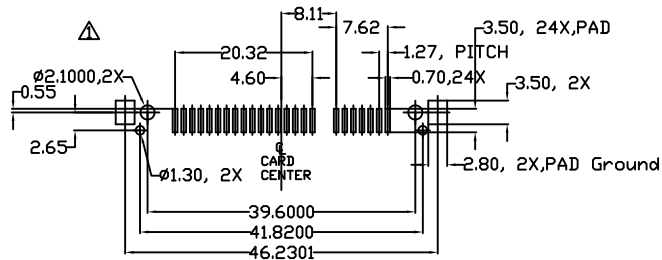
C



D



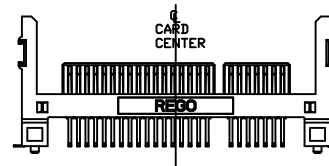
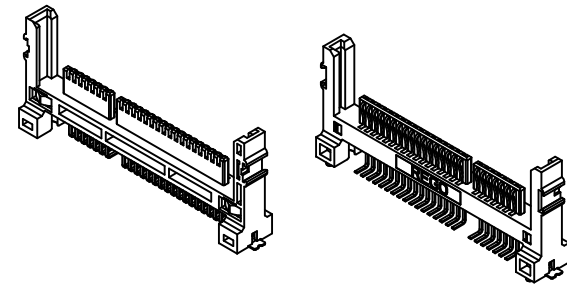
E



PCB T=1.0±0.1
TOLERANCE: ±0.1
RECOMMENDED P.C. BOARD LAYOUT


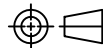
NOTES:

- MATERIAL:
 - 1-1 Housing: Engineering plastic, LCP with G.F reinforced, black per UL 94V-0 rate.
 - 1-2 Terminal: Phosphor Bronze, per JIS 5210, 0.2t
- PLATING:
 - 2-1 CONTACTS: 0.254 μm (10 μ") gold plating in contact area, and underplated with 1.27 μm (50 μ") min. Nickel over all.
 - 2-2 Solder zone: 2.54 μm (100 μ") matte Tin, 1.27 μm (50 μ") min. Nickel underplating over all.
- RoHS compliant products.
- OPERATING TEMPERATURE: -40°C~+85°C



PROPRIETARY NOTE:

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| | | |
|---|-----------------|--|
| .X ± 0.30 | APPROVED: Chris |  http://www.rego.com.tw |
| .XX ± 0.20 | CHECKED: Denny | |
| .XXX ± 0.15 | DRAWN: Bryan | |
| X* ± 3' | | TITLE: CFast Host Connector Type I & Type II Vertical Push Pull w/o Shield |
|  | UNITS: mm | SCALE: NONE |
| | | PART NO: 821101-1100150 |
| | | SHEET: 1 of 1 |

| | | |
|-----|-------------|------------|
| A | RELEASE | 06.24.2014 |
| REV | DESCRIPTION | DATE |

1 2 3 4 5 6 7 8 9 10